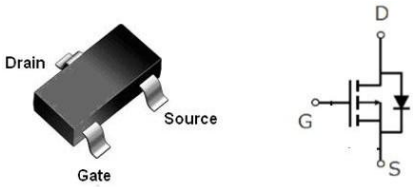
Features

- *Low $R_{DS(on)}$ @V_{GS}=-10V*
- *-5V Logic Level Control*
- *P Channel SOT23 Package*
- *Pb−Free, RoHS Compliant*

$V_{(BR)DSS}$	$R_{DS(ON)}$ Typ	I_D Max
-30V	44mΩ @-10V	-4A
	51mΩ @ -4.5V	

Applications

- Load Switch
- Switching circuits
- High-speed line driver
- Power Management Functions



SOT23

Order Information

Product	Package	Marking	Packing	Min Unit Quantity
AO3401	SOT23	A19T	3000PCS/Reel	3000PCS

Absolute Maximum Ratings

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Symbol	Parameter		Rating	Unit
Common Ratings (T_A=25°C Unless Otherwise Noted)				
V_{GS}	Gate-Source Voltage		±16	V
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage		-30	V
T_J	Maximum Junction Temperature		150	°C
T_{STG}	Storage Temperature Range		-50 to 150	°C
Mounted on Large Heat Sink				
I_{DM}	Pulse Drain Current Tested①	T_A=25°C	-16	A
I_D	Continuous Drain Current	T_A=25°C	-4	A
		T_A=70°C	-3.2	
P_D	Maximum Power Dissipation	T_A=25°C	1.2	W
		T_A=70°C	0.9	
R_{JA}	Thermal Resistance Junction-Ambient		80	°C/W

Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	V_{GS}=0V I_D=-250μA	-30	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current(T_A=25℃)	V_{DS}=-30V, V_{GS}=0V	--	--	-1	μA
	Zero Gate Voltage Drain Current(T_A=125℃)	V_{DS}=-24V, V_{GS}=0V	--	--	-100	uA
I_{GSS}	Gate-Body Leakage Current	V_{GS}=±16V, V_{DS}=0V	--	--	±100	nA
$V_{GS(TH)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=-250μA	-0.5	-0.8	-1.2	V
$R_{DS(ON)}$	Drain-Source On-State Resistance②	V_{GS}=-10V, I_D=-4A	--	44	60	mΩ
$R_{DS(ON)}$	Drain-Source On-State Resistance②	V_{GS}=-4.5V, I_D=-3A	--	51	65	mΩ
$R_{DS(ON)}$	Drain-Source On-State Resistance②	V_{GS}=-3.3V, I_D=-3A	--	58	80	mΩ
Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
C_{iss}	Input Capacitance	V_{DS}=-15V, V_{GS}=0V, f=1MHz	--	655	--	pF
C_{oss}	Output Capacitance		--	65	--	pF
C_{rss}	Reverse Transfer Capacitance		--	53	--	pF
Q_g	Total Gate Charge	V_{DS}=-15V I_D=-4A, V_{GS}=-4.5V	--	7.2	--	nC
Q_{gs}	Gate Source Charge		--	1.5	--	nC
Q_{gd}	Gate Drain Charge		--	2.6	--	nC
Switching Characteristics @ T_J = 25°C (unless otherwise stated)						
$t_{d(on)}$	Turn on Delay Time	V_{DD}=-15V, I_D=-2A, R_G=3.3Ω, V_{GS}=-10V	--	7	--	ns
t_r	Turn on Rise Time		--	3.8	--	ns
$t_{d(off)}$	Turn Off Delay Time		-	35	--	ns
t_f	Turn Off Fall Time		--	10.5	--	ns
Source Drain Diode Characteristics						
I_{SD}	Source drain current(Body Diode)	T_A=25℃	--	--	-2	A
V_{SD}	Forward on voltage②	T_j=25℃, I_{SD}=-4A, V_{GS}=0V	--	-0.88	-1.2	V

Notes:

① Pulse width limited by maximum allowable junction temperature

②Pulse test ; Pulse width 300 s, duty cycle 2%.

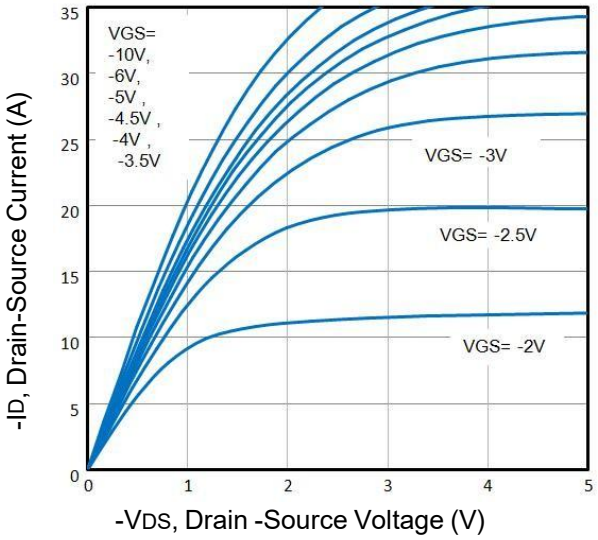


Fig1. Typical Output Characteristics

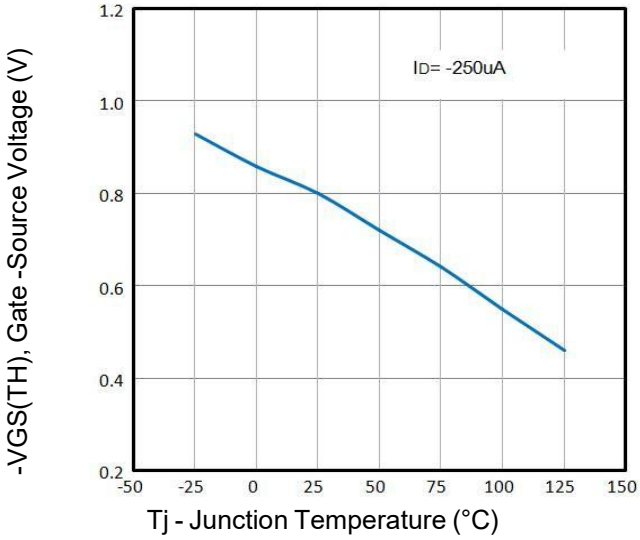


Fig2. Normalized Threshold Voltage Vs. Temperature

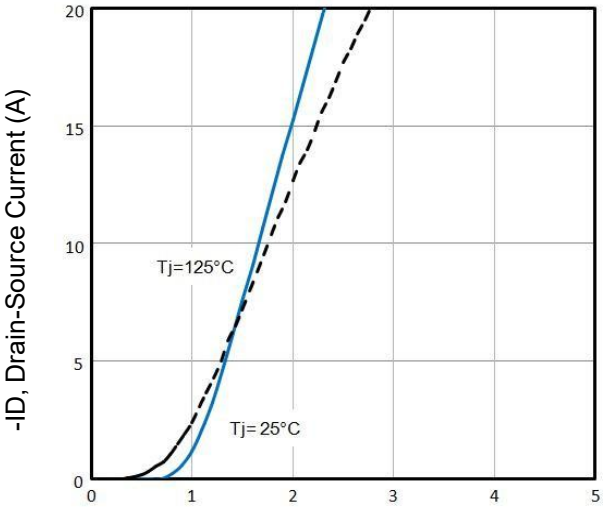


Fig3. Typical Transfer Characteristics

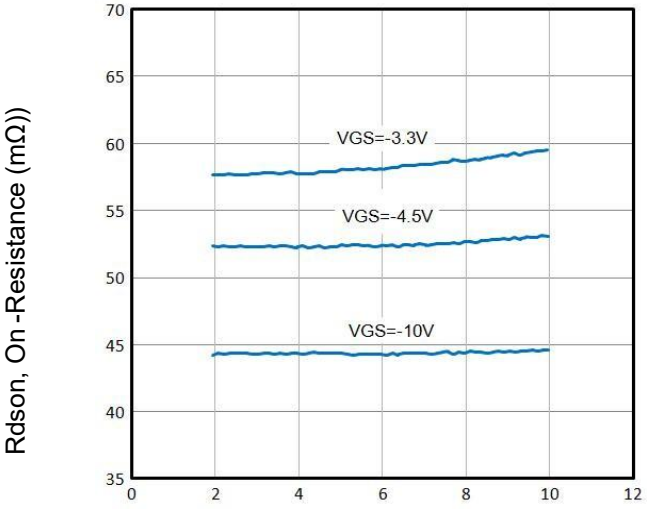


Fig4. On-Resistance vs. Drain Current and Gate

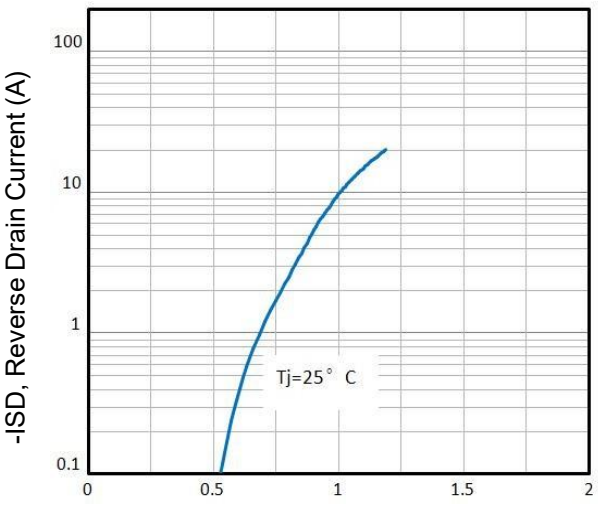


Fig5. Typical Source-Drain Diode Forward Voltage

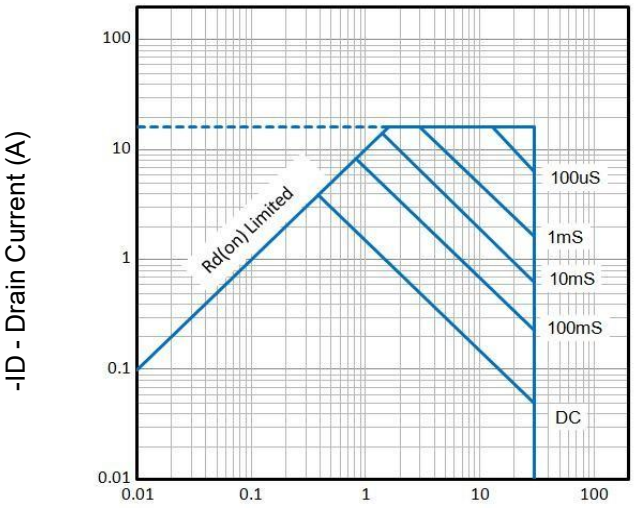


Fig6. Maximum Safe Operating Area

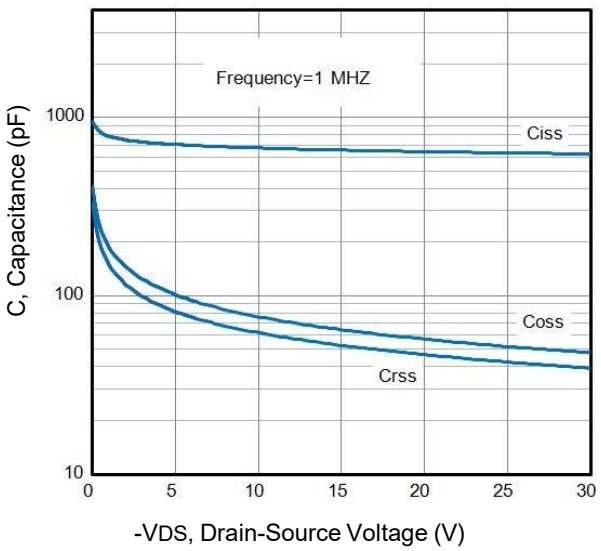


Fig7. Typical Capacitance Vs. Drain-Source Voltage

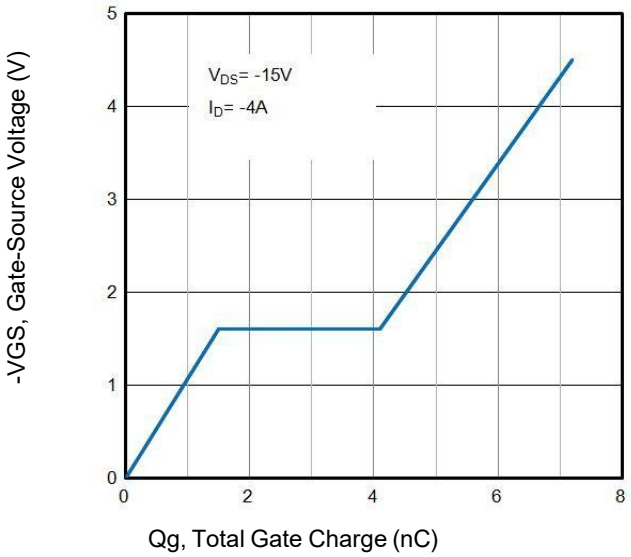


Fig8. Typical Gate Charge Vs. Gate-Source Voltage

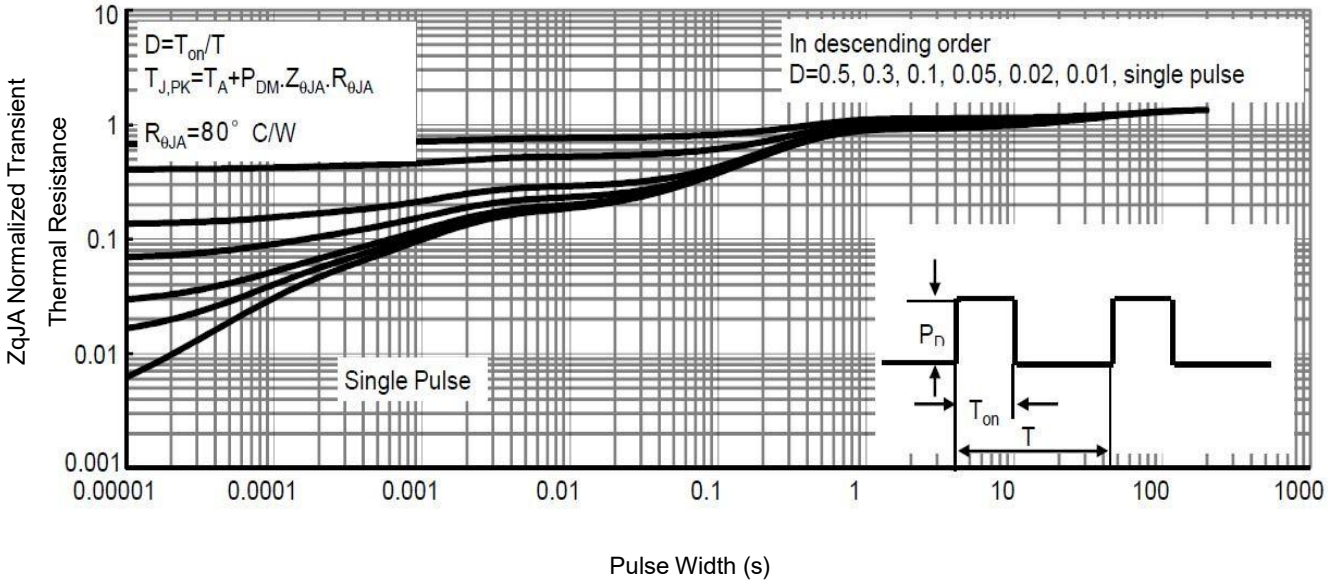


Fig9. Normalized Maximum Transient Thermal Impedance

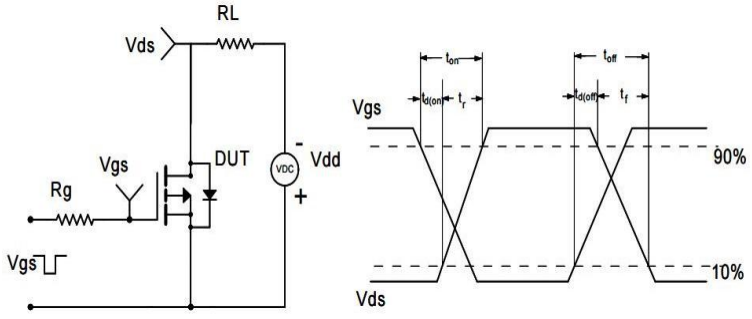
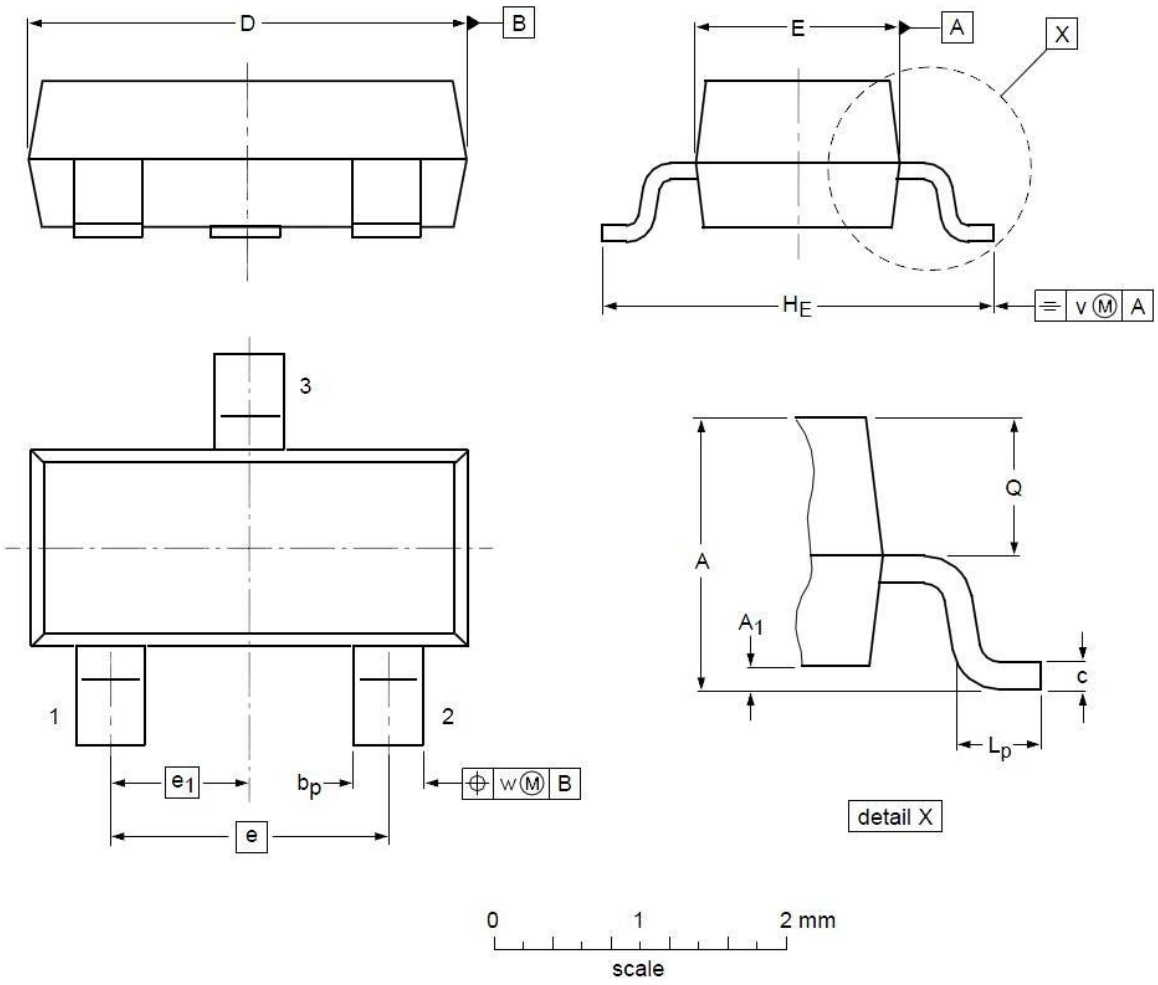


Fig10. Switching Time Test Circuit and waveforms

SOT23 Mechanical Data



DIMENSIONS (unit : mm)

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
A	0.90	1.01	1.15	**A_1**	0.01	0.05	0.10
b_p	0.30	0.42	0.50	**c**	0.08	0.13	0.15
D	2.80	2.92	3.00	**E**	1.20	1.33	1.40
e	--	1.90	--	**e_1**	--	0.95	--
H_E	2.25	2.40	2.55	**L_p**	0.30	0.42	0.50
Q	0.45	0.49	0.55	**v**	--	0.20	--
w	--	0.10	--				